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# RENESAS

# HD74BC640A

# Octal Bus Transceivers With 3 State Outputs

REJ03D0290-0200Z (Previous ADE-205-026 (Z)) Rev.2.00 Jul.16.2004

### Description

The HD74BC640A provides high drivability and operation equal to or better than high speed bipolar standard logic IC by using Bi-CMOS process. The device features low power dissipation that is about 1/5 of high speed bipolar logic IC. When the frequency is 10 MHz. The device has eight bus transceivers with three state outputs in a 20 pin package. Each device has an active low enable input ( $\overline{G}$ ) and a direction control input, DiR. When DiR is high, data flows from the A inputs to the B outputs. When DiR is high, data flows from the B inputs to the A outputs. When enable inputs ( $\overline{G}$ ) is high, disables both A and B ports by placing then in a high impedance.

### Features

- Input/Output are at high impedance state when power supply is off.
- Input pins can be open, when not used, owing to built in input pull up circuit.
- Input is TTL level.
- Wide operating temperature range Ta = -40 to +85°C.
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74BC640AFPEL	SOP-20 pin (JEITA)	FP-20DAV	FP	EL (2,000 pcs/reel)

### **Function Table**

Control Inputs		
G	DIR	Operation
L	L	B data to A bus
L	Н	Ā data to B bus
н	X	Isolation

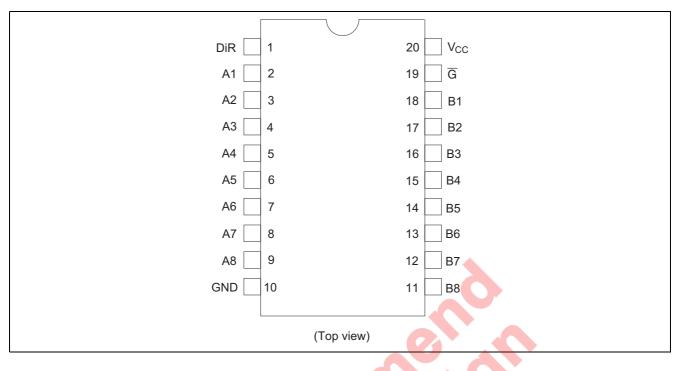
H : High level

L : Low level

X : Immaterial



#### **Pin Arrangement**



### **Absolute Maximum Ratings**

ltem	Symbol 🧹		Rating	Unit
Supply voltage	V <sub>cc</sub>		–0.5 to +7.0	V
Input diode current	I <sub>IK</sub>	•	±30	mA
Input voltage	V <sub>IN</sub>		–0. <mark>5 to +7</mark> .5	V
Output voltage	V <sub>OUT</sub>		-0.5 to +7.5	V
Off state output voltage	V <sub>OUT(off)</sub>		-0.5 to +5.5	V
Storage temperature	Tstg		-65 to +150	°C

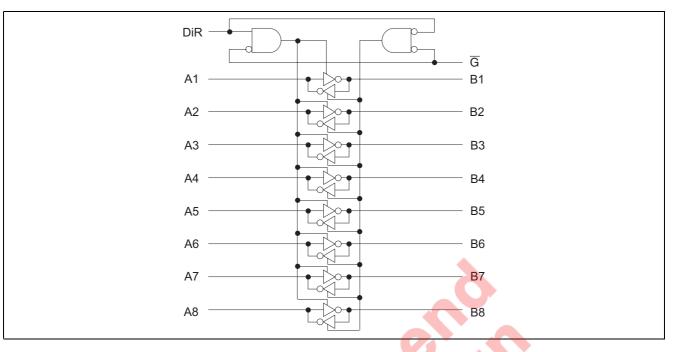
Note: 1. The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

### **Recommended Operating Conditions**

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V <sub>cc</sub>	4.5	5.0	5.5	V
Input voltage	V <sub>IN</sub>	0	—	V <sub>cc</sub>	V
Ouput voltage	V <sub>OUT</sub>	0	—	V <sub>cc</sub>	V
Operating temperature	Topr	-40	—	85	°C
Input rise/fall time*1	t <sub>r</sub> , t <sub>f</sub>	0	—	8	ns/V

Note: 1. This item guarantees maximum limit when one input switches. Waveform: Refer to test circuit of switching characteristics.

### Logic Diagram



# **Electrical Characteristics** (Ta = -40 to $+85^{\circ}$ C)

ltem	Symbol	V <sub>cc</sub> (V)	Min	Max	Unit	Test Conditions
Input voltage	V <sub>IH</sub>		2.0	_	V	
	V <sub>IL</sub>			0.8	V	
Output voltage	V <sub>OH</sub>	4.5	2.4		V	$I_{OH} = -3 \text{ mA}$
		4.5	2.0		V	I <sub>он</sub> = –15 mA
	V <sub>OL</sub>	4.5	-	0.5	V	I <sub>OL</sub> = 48 mA
		4.5		0.55	V	I <sub>OL</sub> = 64 mA
Input diode voltage	V <sub>IK</sub>	4.5		-1.2	V	I <sub>IN</sub> = -18 mA
Input current	l,	5.5	4	-250	μA	$V_{IN} = 0 V$
		5.5	_	100	μA	An or Bn, $V_{IN} = 5.5 V$
		5.5		1.0	μA	DiR or $\overline{G}$ , V <sub>IN</sub> = 5.5 V
		5.5		100	μA	DiR or $\overline{G}$ , V <sub>IN</sub> = 7 V
Output short circuit current*1	l <sub>os</sub>	5.5	-100	-225	mA	$V_0 = 0 V, V_{IN} = 0 \text{ or } 5.5 V$
Off state output current	I <sub>OZH</sub>	5.5	_	-100	μA	$V_0 = 2.7 V$
	IOZL	5.5	—	-250	μA	$V_{0} = 0.5 V$
Supply current	I <sub>CCL</sub>	5.5	—	29.5	mA	V <sub>IN</sub> = 0 or 5.5 V
						All outputs is "L"
	I <sub>CCH</sub>	5.5	—	2.5	mA	V <sub>IN</sub> = 0 or 5.5 V
						All outputs is "H"
	I <sub>CCZ</sub>	5.5	—	4.5	mA	V <sub>IN</sub> = 0 or 5.5 V
						All outputs is "Z"
	I <sub>CCT</sub> * <sup>2</sup>	5.5	—	1.5	mA	V <sub>IN</sub> = 3.4 or 0.5 V

Notes: 1. Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

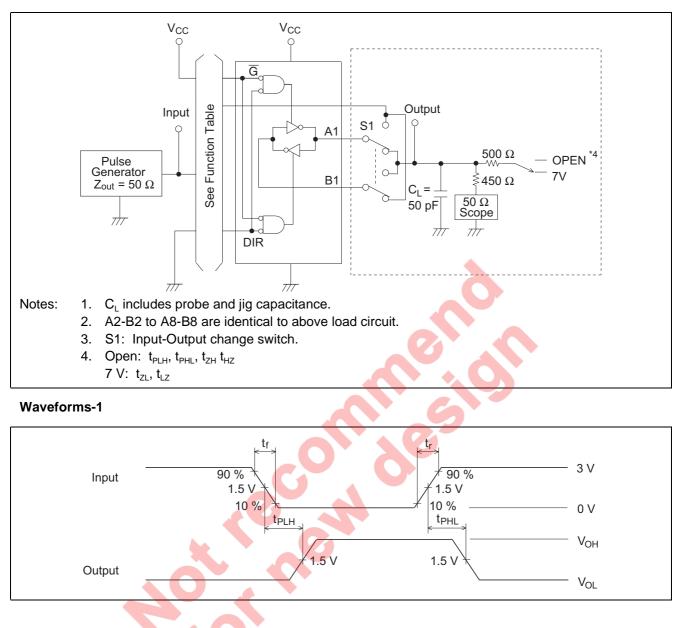
2. When input by the TTL level, it shows  $\rm I_{\rm CC}$  increase at per one input pin.

## Switching Characteristics ( $C_L = 50 \text{ pF}$ )

		Ta = 25°C V <sub>cc</sub> = 5.0 V			0 to +85°C			
				$V_{cc} = 5.0 \text{ V} \pm 10\%$				
Item	Symbol	Min	Max	Min	Max	Unit	Test Conditions	
Propagation delay time	t <sub>PLH</sub>	3.0	6.0	3.0	7.0	ns	An to Bn	
	t <sub>PHL</sub>	3.0	6.0	3.0	7.0			
	t <sub>PLH</sub>	3.0	6.0	3.0	7.0	ns	Bn to An	
	t <sub>PHL</sub>	3.0	6.0	3.0	7.0			
Output enable time	t <sub>zH</sub>	3.0	9.0	3.0	11.0	ns	G to Bn	
	t <sub>zL</sub>	3.0	9.0	3.0	11.0			
	t <sub>zH</sub>	3.0	9.0	3.0	11.0	ns	G to An	
	t <sub>ZL</sub>	3.0	9.0	3.0	11.0			
Output disable time	t <sub>HZ</sub>	3.0	8.0	3.0	10.0	ns	G to Bn	
	t <sub>LZ</sub>	3.0	8.0	3.0	10.0			
	t <sub>HZ</sub>	3.0	8.0	3.0	10.0	ns	G to An	
	t <sub>LZ</sub>	3.0	8.0	3.0	10.0			
Input capacitance	CIN	3.0 (Тур)		—	—		V <sub>IN</sub> = V <sub>CC</sub> or GND	
Output capacitance	CI/O	15.0 (Typ)		_		pF	$V_{VO} = V_{CC}$ or GND	

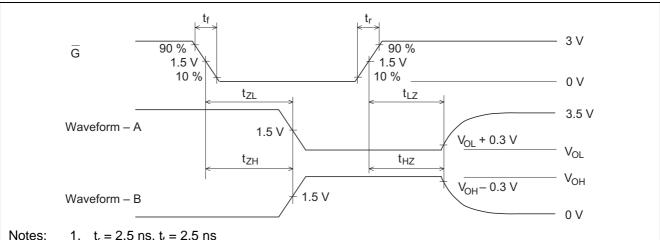


#### **Test Circuit**





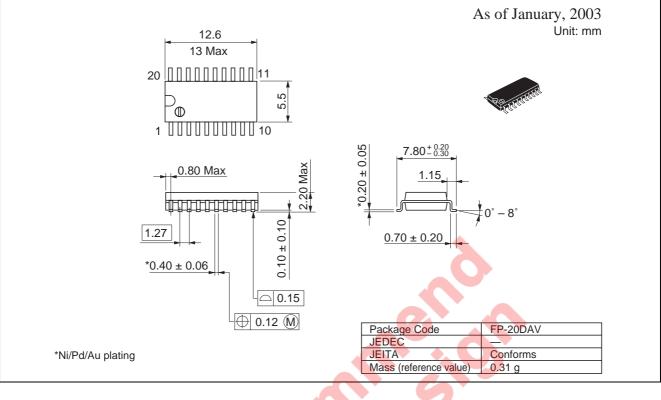
#### Waveforms-2



- 1.  $t_r = 2.5 \text{ ns}, t_f = 2.5 \text{ ns}$ 
  - 2. Input waveforms: PRR = 1 MHz, duty cycle 50%
  - 3. Waveform-A shows input conditions such that the output is "L" level when enable by the output control.
  - 4. Waveform-B shows input conditions such that the output is "H" level when enable by the output control.

Rev.2.00, Jul.16.2004, page 6 of 7

### **Package Dimensions**





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